Nonlinear charge transport induced by gate voltage oscillation in few-layer MnBi₂Te₄

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Abstract

Nonlinear charge transport, including nonreciprocal longitudinal resistance and nonlinear Hall effect, has garnered significant attention due to its ability to explore inherent symmetries and topological properties of novel materials. An exciting recent progress along this direction is the discovery of significant nonreciprocal longitudinal resistance and nonlinear Hall effect in the intrinsic magnetic topological insulator MnBi₂Te₄ induced by the quantum metric dipole. Given the importance of this finding, the inconsistent response with charge density, and conflicting requirement of C_{3z} symmetry, it is imperative to elucidate every detail that may impact the nonlinear transport measurement. In this study, we reveal an intriguing experimental factor that inevitably gives rise to sizable nonlinear transport signal in MnBi₂Te₄. We demonstrate that this effect stems from the gate voltage oscillation caused by the application of a large alternating current to the sample. Furthermore, we propose a methodology to significantly suppress this effect by individually grounding the voltage electrodes during the second-harmonic measurements. Our investigation emphasizes the critical importance of thoroughly assessing the impact of gate voltage oscillation before determining the intrinsic nature of nonlinear transport in all 2D material devices with an electrically connected operative gate electrode.

Main text

The observation of nonlinear Hall effect (NHE) in systems preserving time-reversal symmetry offers valuable insights into the underlying structure of the Berry curvature^{1–}⁴, distinct from the integral of Berry curvature revealed by the anomalous Hall effect (AHE)^{5,6}. Furthermore, recent theoretical studies have revealed that the quantum metric can also induce a NHE^{7,8}. This discovery is of great importance as it establishes a profound connection between quantum metric and NHE, underscoring the role of quantum geometry in condensed matter physics⁹. Specifically, quantum metric and Berry curvature are recognized as the real and imaginary parts of quantum geometry, respectively. While Berry curvature has been extensively studied and associated with

various physics effects, such as the anomalous Hall effect^{5,6}, the quantum metric has received comparatively less attention because of its weak correlation with measurable physical quantities. In contrast to NHE, which is primarily linked to the topological properties of the Bloch wave of electrons, nonreciprocal longitudinal resistance (NLR) is typically attributed to the breaking of inversion symmetry¹⁰, providing complementary insights into the interplay between topology and symmetry in quantum materials. Experimental observations of NLR have been reported in various systems, such as Bi helix¹¹, polar semiconductor BiTeBr¹⁰, noncentrosymmetric superconductors^{12–14}, trigonal tellurium¹⁵, and quantum anomalous Hall effect system¹⁶. In addition to their significance in fundamental physics, NHE and NLR hold great potential for applications in the design of novel quantum materials and devices¹⁷, such as high-frequency rectification¹⁸ and terahertz detection¹⁹.

In the intrinsic antiferromagnetic (AFM) topological insulator MnBi₂Te₄, recent experiments have demonstrated the existence of NHE and NLR, which are attributed to the quantum metric dipole owing to the unique parity and time-reversal symmetries^{20,21}. In this paper, we report a previously overlooked measurement issue in 2D MnBi₂Te₄ devices, which can induce significant nonlinear charge transport signals, arising from the gate voltage oscillation caused by the application of a large alternating current (AC). Moreover, this issue has a general impact on all the NHE and NLR measurements of 2D material devices with operative gate electrode. Our study not only highlights the necessity of evaluating the contribution of gate voltage oscillation, but also provides a new paradigm in the nonlinear transport measurement of 2D material devices.

Nonlinear charge transport in MnBi₂Te₄

MnBi₂Te₄ is an intriguing material known as an intrinsic AFM topological insulator^{22–25}. It exhibits quantum anomalous Hall effect in the odd-number septuple-layer (SL) samples²⁶, characterized by dissipationless edge states with quantized Hall conductance, while it displays an axion insulator state in the even-SL sample, which is characterized by the presence of helical edge current with zero Hall plateau in low field region^{27,28}. Our six-SL MnBi₂Te₄ flakes is exfoliated onto 285-nm SiO₂/Si substrates

by using the Scotch tape method as reported previously²⁷. Figure 1a illustrates the schematic diagram of our measurement setup. The AC is applied by Keithley 6221 current source with the frequency typically set at 13 Hz. Longitudinal voltage and transverse Hall voltage are simultaneously measured by two lock-in amplifiers connected to contacts 1-3 and contacts 1-2, respectively. The carrier density of the sample can be controlled by applying the gate voltage (*V*_G) using a Keithley 2400 source meter. In Fig. 1b, we present the current-voltage (IV) curves for both the longitudinal and transverse directions. The IV curve for the longitudinal direction shows sublinear behavior, which exhibits slight deviations from the previously reported results^{20,21}. We attribute this discrepancy to the relatively high resistance in our sample, which can lead to voltage-induced scattering effects between the edges of the sample²⁹. We also measured the IV curve by the direct current (DC) method, which is consistent with the AC method (see Fig. S2). Meanwhile, the transverse voltage V_{yx}^{ω} remains very small compared to V_{xx}^{ω} , and the variation of V_{yx}^{ω} with $V_{\rm G}$ will be discussed in Fig. 3.

As depicted in Fig. 1c, the observed loop behavior of the second-harmonic (2 ω) Hall voltage ($V_{yx}^{2\omega}$) around zero magnetic field is believed to be closely related to two different AFM states in even-layer MnBi₂Te₄^{20,21,30}. To be more specific, in the AFM I state (-0 T), characterized by sweeping the magnetic field from -4 T to 0 T, the value of $V_{yx}^{2\omega}$ is positive. While in the AFM II state (+0 T), where the magnetic field is swept from 4 T to 0 T, the value of $V_{yx}^{2\omega}$ is found to be negative (the raw data can be found in Fig. S5). Such loop, related to two different AFM states, is also observed in the first harmonic (1 ω) Hall signal by tuning the electric field using a dual-gate device. This phenomenon is attributed to the opposite Berry curvature in adjacent layers³⁰.

As shown in Fig. 1d, the $V_{xx}^{2\omega}$ deviates from the quadratic behavior observed in other systems^{10,11}. This departure is attributed to the sublinear behavior of the IV curve within the high resistive region as discussed in supplementary materials (see Note 4 and Fig. S3). In Fig. 1e, the nonlinear Hall voltage exhibits a quadratic scaling with the injected current I^{ω} , consistent with previous reports^{1,2,20,21}. To evaluate the strength of

the NHE, we utilize the second harmonic of anomalous Hall voltage $(\Delta V_{yx}^{2\omega})$, which is calculated from the signals at AFM II and AFM I states: $\Delta V_{yx}^{2\omega} = (V_{yx}^{2\omega}(+0T) - V_{yx}^{2\omega}(-0T))/2$. The magnitude of $\Delta V_{yx}^{2\omega}$ reaches -0.25 mV at $I = 10 \mu$ A, which is comparable to the value in previous results^{20,21}. Furthermore, it is evident in Fig. 1f that the signal gradually decreases as the temperature approaches the Neel temperature. Above the Neel temperature, the signal disappears within the limit of measurement.

During the experiments, we stumble upon an intriguing question: the nonlinear signals display a dramatic change when we alter the grounding contact. The measurement configuration employed in this study is illustrated in Fig. 2a. Here we introduce two switches, Ss and S_D, to independently control the grounding. Figure 2b presents the measurement results of the NLR with different grounding contacts. When S_S is switched on, the $V_{13}^{2\omega}$ value exhibits a dip followed by a peak as the V_G increases. However, when S_D is switched on (Ss is disconnected), the $V_{13}^{2\omega}$ initially increases before transitioning to a negative value, which is nearly opposite to the results with the grounded source electrode. Meanwhile, the first harmonic signal of longitudinal voltage V_{13}^{ω} shows no difference between these two grounding conditions (see Fig. S6).

It is worth noting that the only alteration throughout the experimental procedure is the toggling of different switches. To clarify, the red clamp (positive electrode) of the current source (Keithley 6221) is consistently connected to the drain terminal, while the black clamp (negative electrode) is connected to the source terminal. The positive and negative input terminals of the lock-in amplifier are consistently connected to contact 1 and contact 3, respectively. As the output of the current source is isolated from the ground, we can ground the positive electrode. This unexpected behavior highlights the strong relevance between the grounding conditions and the resultant NLR response, which also suggests the possibility that a significant portion of the observed nonlinear signal is due to grounding artifacts rather than intrinsic material properties.

Nonlinear charge transport induced by gate voltage oscillation

In the following section, we will delve into the nonlinear signal using a simplified

model. Notably, the simulation results obtained from this model exhibit consistent alignment with the experimental measurements.

At first, we start with discussing the situation of nonreciprocal longitudinal resistance. To ensure simplicity and clarity, we utilize positive and negative DC instead of AC. The equivalent of AC and DC is discussed in supplementary materials (see supplementary Note 1). To illustrate the issue without losing generality, we consider the case when S_S is switched on, thus the voltage potential of the source contact V_S is set to zero.

When a positive current is applied (indicated by the red arrow in Fig. 2a), the voltage distribution on the sample is depicted by the red line in Fig. 2d. In this case, the voltage at contact 3 (V_3) is larger than the source electrode ($V_S = 0$ V). Furthermore, the effective gate voltage (V_G^{eff}) on the sample (the red line in Fig. 2e), which is defined as the difference between the applied V_G and the voltage of the sample at different positions (V_{sample}), is smaller than the V_G applied by Keithley 2400. In the general transport measurements, the difference between V_G^{eff} and V_G can be neglected. However, in the case of 6-SL MnBi₂Te₄, this discrepancy can be attributed to the presence of large longitudinal resistance, as illustrated by the IV curve in Fig. 1b and resistance peak in the inset of Fig. 2c, combining with the large current during second harmonic measurements.

However, when a negative current is applied (indicated by the green arrow in Fig. 2a), the voltage potential on the sample becomes negative (green line in Fig. 2d). Hence, the $V_{\rm G}^{\rm eff}$ on the sample is larger than the applied $V_{\rm G}$ (green line in Fig. 2e). Consequently, the actual $V_{\rm G}$ experienced by the sample is always oscillating when applying a large AC through the drain and source electrodes.

So far, we have demonstrated that the positive (negative) current can decrease (increase) the $V_{\rm G}^{\rm eff}$. This behavior is clearly depicted in Fig. 2c, where the dash lines correspond to the simulated longitudinal voltage of DC measurements under the consideration of the shift of $V_{\rm G}^{\rm eff}$ as described in Fig. 2e. We find that the longitudinal resistance behaves as a right (left) shift for positive (negative) current compared to that measured by an AC of 10 μ A. Besides that, the resistance is also sensitive to applied

 $V_{\rm G}$ as displayed by the peak structure in the inset of Fig. 2c. These two typical characteristics lead to a sizable difference in longitudinal resistance between positive and negative currents. For example, the measured voltage V_{13} has a difference of 6 mV between the 10-µA positive and negative currents, when the $V_{\rm G}$ was set at 45 V, where the resistance changes dramatically. This difference reaches approximately one percent of the 1 ω signal, which can serve as a distinctive characteristic of nonreciprocal charge transport.

The nonreciprocal feature becomes more evident in IV curves as depicted in Fig. 2f. For example, in the p-type region, the IV curve exhibits a reduced slope compared to the ideal linear IV curve with positive current. This arises from the decreased V_G^{eff} and smaller resistance. In contrast, when the current is negative, the IV curve displays a heightened slope due to the increased V_G^{eff} and larger resistance. This behavior can also be found in the n-type region, but the curvature is totally different due to the opposite sign of dR_{xx}/dV_G compared to that in the p-type region. These non-antisymmetric IV curves are typical characteristics of nonreciprocal charge transport³¹. Moreover, when the grounding contact is switched from source to drain electrode, all the signs or trends discussed in Fig. 2c-2f would be reversed. By employing this simple model, we conducted simulations to reproduce the 2ω signal using the $R_{xx}-V_G$ data in Fig. 2c, which demonstrates a remarkable agreement with the experimental measurements (see Fig. S1).

In normal cases, the applied current is relatively small and the longitudinal voltage across the sample is regarded as a perturbation in the electrical transport measurements. However, in the case of nonreciprocal transport, the applied current is typically on the order of tens of micro-amperes, or even milliamps in some instances^{10,31–33}. Such large currents can induce significant voltage differences between drain and source electrodes. Furthermore, in 2D materials both the displacement field and charge carrier density can be dramatically tuned by the gate voltage^{1,20,21}, which can produce large resistance and considerable dR_{xx}/dV_G , consequently leading to pronounced signals in the nonreciprocal charge transport measurement.

Subsequently, we assess the influence of gate voltage oscillation on the NHE. As

previously mentioned, even though the zero-field Hall voltage is relatively small compared to the longitudinal voltage, it still exhibits variations at different $V_{\rm G}$. As shown in Fig. 3a, the voltage of the AHE at zero magnetic field, represented by $\Delta V_{yx}^{\omega} =$ $(V_{yx}^{\omega}(+0T) - V_{yx}^{\omega}(-0T))/2$, displays a sign reversal behavior with the increase of $V_{\rm G}$ and approaches to zero in the heavily n- and p-doped regions. The observed AHE in our sample is consistent with the layer Hall effect reported in MnBi₂Te₄, which is attributed to the opposite Berry curvature in adjacent layers³⁰. However, for the second harmonic measurements, as depicted in Fig. 3b, the loop of nonlinear Hall voltage $V_{yx}^{2\omega}$ is completely inverted when switching the ground electrode between the drain and source contacts. This is in stark contrast to the negligible differences observed in the 1ω anomalous Hall voltage V_{yx}^{ω} . This feature is incomprehensible in the framework of quantum metric dipole^{20,21}, because such an intrinsic quantum effect should not rely on the grounding electrode. However, this phenomenon can be clearly explained by the gate voltage oscillation picture and the 2ω signals are determined by both the gate voltage shift and the value of $d\Delta V_{yx}^{\omega}/dV_G$. When the grounding electrode is changed, the gate voltage shifts towards the opposite direction, resulting in a sign reversal of 2ω Hall voltage. Moreover, Fig. 3c demonstrates that when one of the Hall voltage electrodes (labeled as 1 and 2) is grounded, the amplitude of $\Delta V_{yx}^{2\omega}$ is smaller compared to that with grounded drain or source electrode. This observation can be attributed to the reduced gate voltage oscillation in the sample region around Hall electrodes because the voltage of this region is closer to the zero potential of the ground when electrode 1 or 2 is grounded. However, it is noteworthy that the 1ω data remains unaffected by different grounding conditions (see Fig. S6).

To eliminate the influence of gate voltage oscillation, we take the average of $\Delta V_{yx}^{2\omega}$ obtained by grounding Hall electrodes 1 and 2 separately. The compensated result $\Delta V_{yx}^{2\omega} = (\Delta V_{yx}^{2\omega} (\text{GND}_1) + \Delta V_{yx}^{2\omega} (\text{GND}_2))/2$, is illustrated in Fig. 3d. This calculation is reasonable because the contribution of gate voltage oscillation is totally opposite when grounding electrodes 1 and 2. Furthermore, the current following through the Hall electrodes is completely negligible and it is not necessary to consider the difference in contact resistance of each Hall electrode. In the cases of grounding source or drain electrode, the contact resistance would affect the magnitude of gate voltage oscillation. It is worth noting that, even after the compensation, the second harmonic signals still exist, accounting for approximately one fifth of the original signal. However, it is challenging to draw a definitive conclusion about whether these residual signals are from the intrinsic quantum metric effect. Further experiments are required for this validation.

Nonlinear charge transport with intentional gate voltage oscillation

To further illustrate the above picture, we propose a fresh perspective to shed light on this problem by intentionally introducing gate voltage oscillation, which has the same frequency and is in phase with AC following through source and drain electrodes. As illustrated in Fig. 4a, the gate voltage applied on the sample includes two parts. The DC part is applied by Keithley 2400, and the AC part is generated by a voltage transformer with a primary-to-secondary voltage ratio of 4:1³⁴. As illustrated in Fig. 4b, the NLR signal is negligible when applying a small current $I = 0.2 \mu$ A. However, when the primary voltage of the transformer is set to 5 V, which induces a gate voltage oscillation of 1.25 V, a substantial NLR signal is detected in both p-type and n-type regions.

After successfully demonstrating the generation of nonreciprocal transport by the intentional gate voltage oscillation, we conduct measurements using a larger AC. This allows us to superpose the magnitude of gate voltage oscillation from both the large AC and the transformer. The primary voltage of the transformer is varied from 0 V to 5 V, as shown in Fig. 4c. Notably, all the curves intersected at a single point (-0.5 mV) near the charge neutrality point (CNP), where the nonreciprocal transport signals are expected to be zero due to the zero slope of V_{xx}^{ω} around the resistance peak, i.e., $dV_{xx}^{\omega}/dV_{\rm G} = 0$ at CNP. Further experiments are required to investigate the origin of this deviation. Additionally, we also observed that the application of intentional gate voltage oscillations can reverse the second harmonic signals of the nonlinear Hall effect, as

depicted in Fig. 4d. Specifically, when the primary voltage is set to 3 V, the 2ω Hall voltage exhibits no loop, indicating successful suppression of gate voltage oscillation arising from both the AC and the transformer.

Conclusions

In conclusion, we observed strong nonreciprocal longitudinal resistance and nonlinear Hall effect induced by gate voltage oscillation during the second harmonic measurements in MnBi₂Te₄. In all the previous nonlinear measurements of 2D material devices, only the source electrode (negative electrode of current source) is grounded and the acquired data always contain the contribution of gate voltage oscillation, which may invalidate all the analysis and discussions about the intrinsic mechanisms. Our observations indicate that this artifact becomes more dominate in the following two conditions. Firstly, the longitudinal resistance should be sensitive to the gate voltage, which allows detectable resistance differences for positive and negative currents. This phenomenon is particularly pronounced in hBN-encapsulated devices due to the large geometry capacitance of gate electrode. Secondly, the voltage drop on the sample should be large enough to shift the applied gate voltage, which can be realized in the samples with large resistance and large applied current. Moreover, we propose a method to eliminate the effect of gate voltage oscillation and obtain more intrinsic signals of nonlinear charge transport by individually grounding the electrodes for voltage measurements. Our study emphasizes the crucial importance of evaluating the contribution of gate voltage oscillation before drawing definitive conclusions regarding the intrinsic nature of nonlinear signals in 2D material devices that can be effectively controlled by an in-situ gate electrode.

Figures



Fig. 1 | Nonlinear charge transport in MnBi₂Te₄. a, Schematic diagram of the device and measurement setup. The six-SL MnBi₂Te₄ flake was exfoliated on a 285-nm SiO₂/Si substrate. b, Current dependent first harmonic (1 ω) longitudinal and transverse voltage. c, Second harmonic (2 ω) transverse voltage while sweeping up/down magnetic field. The Inset carton indicates two different states (AFM I/II) at zero magnetic field, respectively. AFM I, sweeping the magnetic field from -4 T to 0 T; AFM II, sweeping the magnetic field from +4 T to 0 T. d, Current-dependent 2 ω longitudinal voltage. e, The difference of 2 ω transverse voltage ($\Delta V_{yx}^{2\omega}$) between AFM II and AFM I at different currents. f, The temperature evolution of $\Delta V_{yx}^{2\omega}$. All the data are acquired with $V_G = 75$ V and T = 1.4 K for (b-e).



Fig. 2 | Nonreciprocal longitudinal resistance induced by gate voltage oscillation. a, Measurement configuration: the red clamp of the Keithley 6221 current source is consistently connected to the drain terminal, while the black clamp was connected to the source terminal. Two switches, Ss and Sp, are introduced to independently control the grounding of the source and drain terminals, respectively. b, Second harmonic signals of NLR obtained by grounding drain or source terminal respectively. c, Gatevoltage dependence of longitudinal resistance (black solid line) around the p-type region measured by using AC $I = 10 \mu A$ at T = 1.4 K. The inset shows the whole profile of resistance peak. The dashed red/green line represent the shift induced by applying positive/negative direct current. d, Longitudinal voltage distribution as a function of the position within the sample for positive current (red line) and negative current (green line). e, The distribution of effective gate voltage within the sample for different current directions. f, The IV curves of n-type and p-type regions due to the shift of gate voltage. The source electrode is grounded in (c-f).



Fig. 3 | Nonlinear Hall effect with different grounding contacts. a, The gatedependent anomalous Hall voltage ΔV_{yx}^{ω} with grounding drain and source contact separately. The two colored regions represent the negative and positive slopes of ΔV_{yx}^{ω} versus gate voltage, respectively. The measurement configuration is illustrated in the inset. b, Nonlinear Hall voltage $V_{yx}^{2\omega}$ obtained by sweeping the magnetic field with the same grounding conditions shown in a. c, The gate-dependent second harmonic Hall voltage $V_{yx}^{2\omega}$ with grounding drain, source, contact 1, and contact 2 separately. The red and blue solid dots correspond to the data obtained from the $\Delta V_{yx}^{2\omega}$ curves by sweeping the magnetic field, as shown in b. d, The compensated data of second harmonic Hall voltage $\Delta V_{yx}^{2\omega}$ obtained by averaging the paired curves in c with grounding Hall electrodes (1 and 2) or source and drain electrodes separately.



Fig. 4| Nonlinear charge transport with intentional gate voltage oscillation. a, Measurement setup for the application of intentional gate voltage oscillation with a voltage transformer. The AC component of gate voltage has the same frequency and phase as the drain-source current. b, Gate-voltage-dependent NLR with applied AC I =0.2 μ A. The primary voltage of the transformer is set to 0 V and 5 V respectively. c, Gate-dependent NLR with applied AC $I = 10 \mu$ A. The primary voltage is varied from 0 V to 5 V. d, The second-harmonic Hall voltage versus the magnetic fields. The loops are offset by 0.7 mV for clarity. Gate-dependent anomalous second harmonic Hall voltage with applied current $I = 10 \mu$ A, the primary voltage is set to 0, 3, and 5 V respectively.

Methods

Crystal growth The MnBi₂Te₄ single crystal was grown by the chemical vapor transport (CVT) method^{35–37}. Mn (99.95%, Alfa Aesar), Te (99.999%, Alfa Aesar), and Bi₂Te₃ (99.999% Alfa Aesar) lumps were meticulously mixed in a 2:2:1 stoichiometric ratio, ground into powder, and placed in a quartz ampoule along with iodine (I₂, 99.99%, 3A) as transport agent in a proportion of 0.3 times the stoichiometric ratio. The sealed quartz ampoule was held at 900 °C over 6 hours ensuring the raw materials were well mixed in a box furnace. Following a controlled cooling process, the sealed quartz ampoule was placed in a tube furnace with a controllable gradient temperature for the CVT-driven crystal growth process. The temperature of the source end and growth end were held at 597 °C and 588 °C respectively for 30 days. Then the quartz ampoule was quenched in water to prevent the side phases. Millimeter-sized MnBi₂Te₄ single crystals can be found at the growth end. The crystal structure and magnetic order of crystals were confirmed through X-ray diffraction (XRD) and magnetic measurements.

Device fabrication MnBi₂Te₄ flakes were exfoliated onto 285-nm SiO₂/Si substrates by using the Scotch tape method in an argon-filled glove box with O₂ and H₂O levels lower than 0.1 ppm. Before exfoliation, all SiO₂/Si substrates were pre-cleaned by air plasma for 5 minutes at ~ 125 Pa pressure. For the transport devices, thick flakes around the target sample were scratched off by using a sharp needle in the glove box. A layer of 270 nm PMMA was spin-coated before electron beam lithography (EBL) and heated at 60 °C for 5 minutes. After the EBL, Cr/Au electrodes (3nm/20-50nm) were deposited by a thermal evaporator connected with an argon-filled glove box. Before the fabrication and sample transfer process, the devices were always spin-coated with a PMMA layer to avoid exposure to air.

Transport measurement Four probe transport measurements were carried out in a cryostat with the lowest temperature of 1.4 K and out-of-plane magnetic field up to 8 T. The first and second harmonic longitudinal and Hall signals were acquired simultaneously via lock-in amplifiers (SR830) with an AC ($0.1 \sim 10 \mu A$, $\sim 13 Hz$)

generated by a Keithley 6221 current source. To correct for the geometrical misalignment, the longitudinal and Hall signals were symmetrized and antisymmetrized with the magnetic field respectively. The back gate voltages were applied by a Keithley 2400 source meter.

Data Availability: All raw and derived data used to support the findings of this work are available from the authors on request.

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Supplementary Information

Nonlinear charge transport induced by gate voltage oscillation in few-layer MnBi₂Te₄

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Note 1: AC method for nonreciprocal charge transport

The nonlinear signal under investigation includes harmonic components such as 2ω , 3ω and higher-order harmonics, resulting from the application of current I^{ω} to the sample. However, it is crucial to emphasize that this paper exclusively concentrates on the analysis of the 2ω , components. Specifically, the focus is on the nonreciprocal longitudinal resistance $(V_{xx}^{2\omega})$ and the nonlinear Hall effect $(V_{yx}^{2\omega})$. Therefore, the voltage difference across the sample can be described as [1]:

$$V = R_0 I (1 + \gamma I)$$

where R_0 and γ represents for the linear resistance and nonreciprocity in the material. In DC method, the voltage difference caused by nonreciprocity can be expressed as:

$$\Delta V_{DC} = \frac{V_{+I} + V_{-I}}{2} = \frac{R_0 I (1 + \gamma I) + R_0 (-I) (1 + \gamma (-I))}{2} = R_0 \gamma I^2$$

While in AC mode, the applied current is represented by a sinusoidal waveform:

$$I = \sqrt{2}I_0 \sin(\omega t + \phi_0)$$

Here, ω , ϕ_0 , represents for the frequency and primary phase of the applied current I^{ω} . So the I^2 can be represents as followed:

$$I^{2} = 2I_{0}^{2}\sin^{2}(\omega t + \phi_{0}) = 2I_{0}^{2}\frac{1 - \cos(2\omega t + 2\phi_{0})}{2}$$
$$= I_{0}^{2}\left\{1 - \sin\left[\frac{\pi}{2} - (2\omega t + 2\phi_{0})\right]\right\}$$
$$= I_{0}^{2}\left\{1 + \sin\left(2\omega t + 2\phi_{0} - \frac{\pi}{2}\right)\right\}$$

Provided that the ϕ_0 is set to zero, the 2ω part of the $R_0\gamma(I^{\omega})^2$ signal is:

$$V^{2\omega} = R_0 \gamma I^2 \sin\left(2\omega t - \frac{\pi}{2}\right)$$

The measured amplitude of voltage by the lock-in is:

$$V_{\text{measure}}^{2\omega} = \frac{\sqrt{2}}{2} V^{2\omega} R_0 \gamma I_0^2 = \frac{\sqrt{2}}{2} \Delta V_{DC}$$

The sign of the measured result can be determined by comparing the phase of the measured $V^{2\omega}$ with the phase of I^2 . According to the formula, the phase of I^2 is set as $-\pi/2$. If the measured phase of $V^{2\omega}$ is $-\pi/2$ (or $\pi/2$), it indicates a positive (or negative)

value for the $V_{\text{measure}}^{2\omega}$.

Note 2: Finite element simulation of gate voltage shifts induced NLR

The simulation was performed with DC mode, specifically in longitudinal direction, to elucidate the fundamental nature of the nonreciprocal longitudinal resistance (NLR) induced by gate voltage shifts. As illustrated in Fig. S1, the voltage potential at the source contact is set to zero by grounding. Therefore, the voltage potential at position X can be expressed as:

$$V_X = \int_S^X IdR = \int_{S'}^X I(y)\rho(y)\frac{dy}{S(y)} + IR_{SS'}$$

where, $\rho_{(y)}$, S(y), $R_{SS'}$, S' represents for resistivity, cross section, contact resistance between the leads and sample, and the position of source electrode. The first term describe the voltage drops across the sample.

Assuming the sample has a regular shape and the current density is uniform, the first term can be reformulated as:

$$V_X = \int_{S'}^{X} I(y)\rho(y) \frac{dy}{S(y)} = \int_{S'}^{X} I \frac{\rho(y)l_{AB}}{S} \frac{dy}{l_{AB}} = \int_{S'}^{X} \frac{IR_{AB}}{l_{AB}} dy$$

where R_{AB} , l_{AB} represents for resistance measured from AB, and length of AB. R_{AB} is a function of effective gate voltage $V_G^{\text{eff}} = V_G - V_y$. So we have:

$$V_X = I\left(R_{SS'} + \int_{S'}^X \frac{IR_{AB}(V_G - V_y)}{l_{AB}} dy\right)$$

the final voltage distribution on the sample can be obtained by iterating this formula. Furthermore, the nonreciprocal voltage $\Delta V = (V_{AB}^+ - V_{AB}^-)/2$ is achieved by applying positive and negative currents. The simulated data is consistent with measurement results (Fig. S1), indicating that this simplified model is good approximation.

We note that, strictly speaking, the $R_{AB}(V_G^{\text{eff}})$ can be replaced by $R_{AB}(V_G)$ only when the current is small (less than 0.2 uA). However, using the $R_{AB}(V_G)$ curve with low current for simulation is not suitable due to the decrease of resistance in large current used for measuring NLR. Therefore, the $R_{AB}(V_G)$ curve with 10 uA was adopted in simulation for iterative purposes. The simulation results suggest the difference between $R_{AB}(V_G)$ and $R_{AB}(V_G^{\text{eff}})$ at 10 uA does not significantly affect the nonlinear signal induced by gate voltage shift.



Fig. S1 Comparison between simulation and measurement results.

Note 3: The IV curve measured from DC and AC method

Fig. S2 shows the IV curve measured using both DC and AC methods, with a temperature of T = 1.4 K and a gate voltage of $V_G = 75$ V. Both the AC and DC results exhibit sublinear behavior in the low current region, as mentioned in the main text. This behavior is probably attributed to voltage-induced scattering effects between the edges of the sample [2].



Fig. S1 IV curve measured with DC and AC method at T = 1.4 K, $V_G = 75$ V

Note 4: $V_{ij}^{2\omega}$ versus V_{xx}^{ω} at $V_{\rm G} = 75$ V and the IV curve at $V_{\rm G} = 30$ V

As mentioned in the main text that the $V_{xx}^{2\omega}$ deviates from parabolic behavior due to its large resistance and sublinear IV curve. In the context of the gate voltage shiftinduced nonlinear signal, we can provide a possible explanation. As discussed in the main text:

$$V_{xx}^{2\omega} \propto \frac{dV_{xx}}{dV_G} \Delta V_G = \frac{dR_{xx}I}{dV_G} \Delta V_G$$

while the shift of gate voltage $\Delta V_G \propto V_{xx} = R_{xx}I$. So we have:

$$V_{xx}^{2\omega} \propto \frac{dR_{xx}(V_G)I}{dV_G} R_{xx}I \propto \frac{dR_{xx}(V_G)}{dV_G} R_{xx}I^2$$

As depicted in the IV curve in Fig. 1b of the main text, the longitudinal resistance V_{xx}^{ω} decreases as the current increases. Hence, the quadratic coefficient for $V_{xx}^{2\omega}$ vs. *I* (Fig. 1d) decreases, leading to the deviation from parabolic behavior.

We plot the $V_{ij}^{2\omega} - V_{xx}^{\omega}$ curve as that[3] in Fig. S3. We argue that what important is the electric field rather the current, given the sublinear IV curve. The second

harmonic electric field $V_{ij}^{2\omega}$ is nearly proportional to the square of longitudinal electric field $(V_{xx}^{\omega})^2$.



Fig. S2 $V_{ij}^{2\omega} - V_{xx}^{\omega}$ results at $V_{\rm G} = 75$ V, T = 1.4 K

Moreover, as plotted in Fig. S4, we observe that when choosing a gate voltage V_G = 30 V, the resistance is smaller compared to the value at gate voltage V_G = 75 V. In this region, the 1 ω IV curve is close to linear, and the $V_{xx}^{2\omega}$ -I exhibits close-to-parabolic behavior.



Fig. S3 the IV curve at $V_G = 30$ V, T = 1.4 K

Note 5: The raw data of the NHE with different grounding conditions

It is evident from the raw data, as shown in Fig. S5, that the nonlinear Hall effect exhibits a loop around zero magnetic field. When the source contact is grounded (the lower two curves), the red curve (sweeping magnetic field from positive to zero) is consistently below the blue curve (sweeping magnetic field from negative to zero). This indicates that the anomalous nonlinear Hall signal $\Delta V_{yx}^{2\omega}$ is negative when the source contact is grounded.

The hysteresis loop exhibits an opposite sign when grounding the drain contact. This is due to the different voltage potential distribution on the sample, resulting in the opposite shift of gate voltage.

Furthermore, the nonlinear signals induced by thermoelectric effects [4,5] can be ruled out based on the results obtained with different grounding contacts. This is because changing the grounding contacts alters the voltage potential distribution while keeping the temperature gradient unchanged.



Fig. S5 the raw data of the nonlinear Hall signal with different grounding conditions

Note 6: 1 ω data with different grounding conditions

Fig. S6 illustrates the 1ω data obtained under different grounding conditions. Both V_{xx}^{ω} and ΔV_{yx}^{ω} exhibit slight differences when the grounding conditions are varied. Besides, the ΔV_{yx}^{ω} shows a significant change when the gate voltage is altered. This change can be attributed to the layer Hall effect caused by the vertical electric field applied on the sample through the back gate voltage[6].



Fig. S4 1 ω data while sweeping gate voltage with 4 different grounding contacts at T = 1.4 K

Note 7: Axion insulator and Chern insulator states in MnBi₂Te₄

Figure. S7 depicts the longitudinal resistivity and Hall resistivity in our MnBi₂Te₄ device. It exhibits axion insulator state, characterized by the zero Hall plateau in the low magnetic field region. While in the high magnetic field, the sample displays Chern insulator state. The Hall resistivity is quantized and the longitudinal resistivity is approaching to zero.



Fig. S7 The 1 ω resistivity and Hall resistivity at T = 1.5 K, $V_G = 75$ V, I = 10 nA

Note 8: $V_{yx}^{2\omega}$ with drain and source grounded in another device

The gate voltage oscillation induced nonlinear Hall effect has been observed in another device. In Fig. S8, the $V_{yx}^{2\omega}$ is shown for grounding the drain and source contacts separately.



Fig. S8 The $V_{yx}^{2\omega}$ of another 6-SL MnBi₂Te₄ device at T = 1.8 K, $V_{\rm G} = 25$ V

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